

# **Atomistic Exploration of Impurity Effects on the Intrinsic Brittleness of Silicon Carbide**

FA9550-11-1-0273

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# Project Overview

## Timeline:

3 year project - initiated September 15, 2011

## Primary Objective:

Utilize advanced atomistic modeling techniques to investigate the role of impurity elements and nonstoichiometry on high temperature SiC crack tip behavior

## Potential Outcomes:

1. Improve understanding of fracture mechanisms in SiC
2. Identify impurity elements that are influential to crack growth in SiC
3. Provide guidance in choosing crack tip constitutive relations
4. Develop a foundation for future atomic-scale investigations of fracture in chemically complex materials

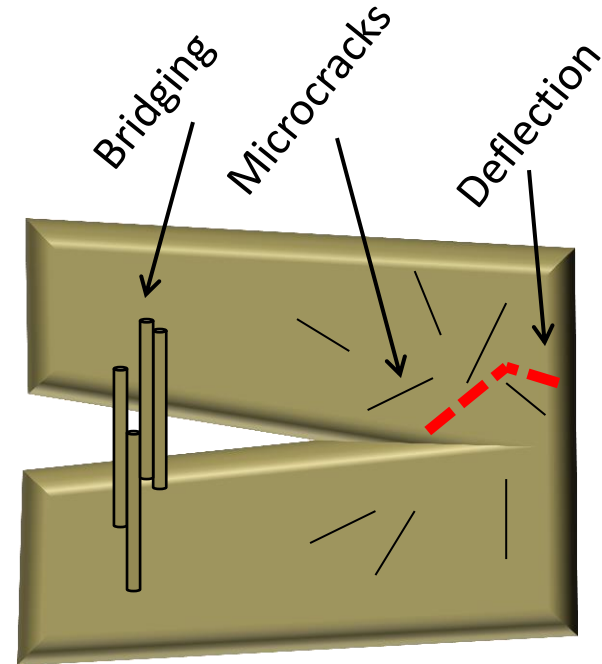
# Context

## Why silicon carbide?

- Large literature
- Significant technological motivation
  - High-T structural applications
  - High-T electronic applications

## Fracture mechanisms in silicon carbide

- Improve crack growth resistance via microscopic mechanisms
- Atomic-scale mechanisms can serve as a “valve” controlling microscopic mechanisms



# Approach

- 1. Identify key crack tip mechanisms and important regions in configuration space**
  - Large 3D atomistic simulations
  - Penny shaped cracks with empirical potentials
  - Investigate crystallography, crack tip geometry, loading type, & temperature
- 2. Examine key mechanisms and configurations more carefully with regard to spatial scale, time scale, interatomic potentials**
  - Concurrently coupled atomistic - discrete dislocation framework
  - *Specific mechanisms*: Variational transition state theory via finite temperature string method
  - *Specific configurations*: Parallel replica + hyperdynamics
- 3. Examine the effect of impurities and nonstoichiometry on the key mechanisms and configurations**
  - QM-based continuum models

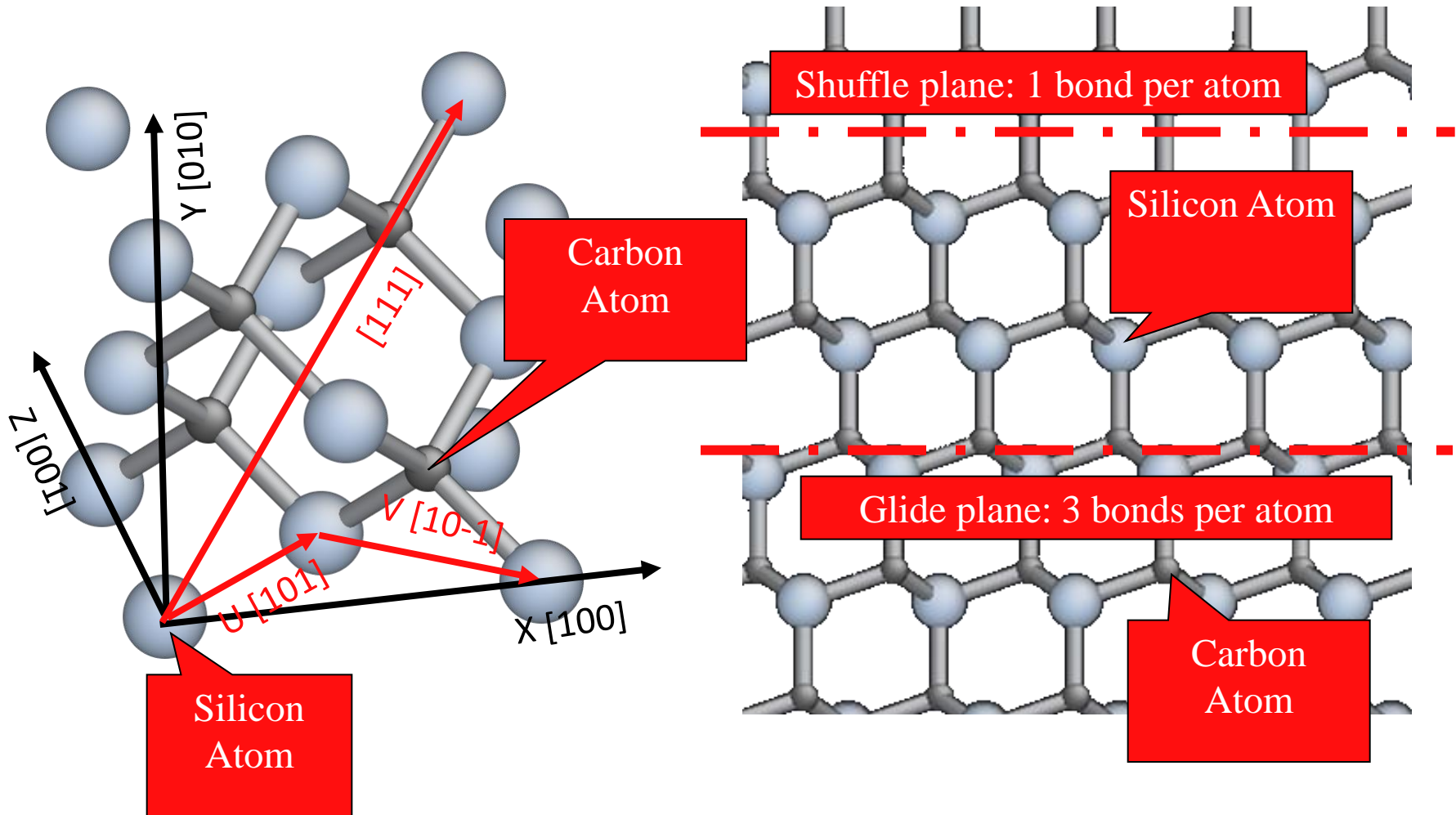
# Some Experimental and Simulation Results from Literature

- **Amelinckx 1960: 6H SiC**
  - Glide traces as a result of plastic flow with optical microscopy and x-ray diffraction microscopy
- **Pilyankevich 1984: 6H SiC**
  - Partial dislocations and stacking fault with TEM after high-temperature plastic deformation
- **Henshall 1977: 6H SiC**
  - $\gamma_s=11.5 \text{ J/m}^2$  below 1000 K and  $\gamma_s=25 \text{ J/m}^2$  above 1400 K obtained from 3-point bend tests on single edge-notched beam specimens
  - Fracture surfaces with plastic deformation, with large cleavage steps
- **Campbell 1989: sintered and hot pressed SiC**
  - Below 1700 K, the material fails by brittle crack extension. Above 1700 K, the material become ductile
- **Pirouz 1999: 6H and 4H SiC**
  - ( $T < T_c$ ) deformation proceeds by the nucleation and glide of single partial dislocations
  - ( $T > T_c$ ) deformation proceeds by the formation and glide of perfect, dissociated, dislocations
- **Kikuchi 2005: 3C SiC**
  - MD simulation 100 K, 111 fracture involves slip in the 111 planes
  - $\gamma_s=2.1 \text{ J/m}^2$

# Presentation Outline

- **Part I: Atomistic model**
  - Direct Molecular dynamics (MD) simulation of SiC crack tip
- **Part II: Analytic continuum model**
  - Competition between crack blunting by plastic deformation and crack propagation
  - Griffith's fracture model [1]: strain energy release rate for fracture
  - Rice's dislocation model [2]: strain energy release rate for dislocation nucleation
  - Dislocation nucleation as a function of temperature and strain rate
  - Calculate elastic constants, surface energies and unstable stacking fault energies
- **Part III: Compare the direct MD simulation results to the continuum fracture/dislocation model**

# Silicon Carbide Terminology



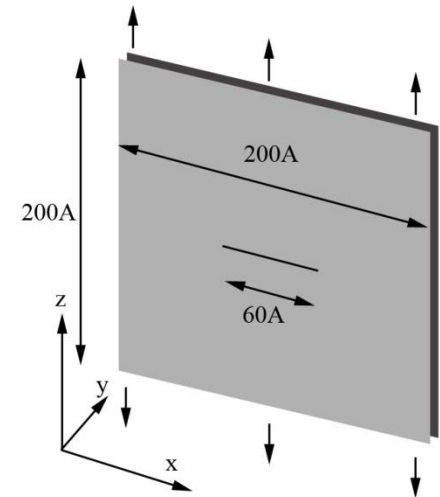
# **Part I:**

# **Molecular dynamics Simulations**



# Simulation Setup (Traditional MD)

- Mode I loading through crack simulations conducted with LAMMPS package
- 200Å x 200Å x 20Å (x x z x y) with a 60Å through crack
- Traction free boundary condition was applied in x and y direction and mode I tensile loading was applied in the z direction, corresponding to the  $\langle 111 \rangle$  direction of the crystal
- Potentials:
  - Devanathan Tersoff potential
  - Erhart Tersoff potential
- Temperature: 0 K to 800 K with 200 K increment
- Strain rate:  $10^7/s$  to  $10^9/s$

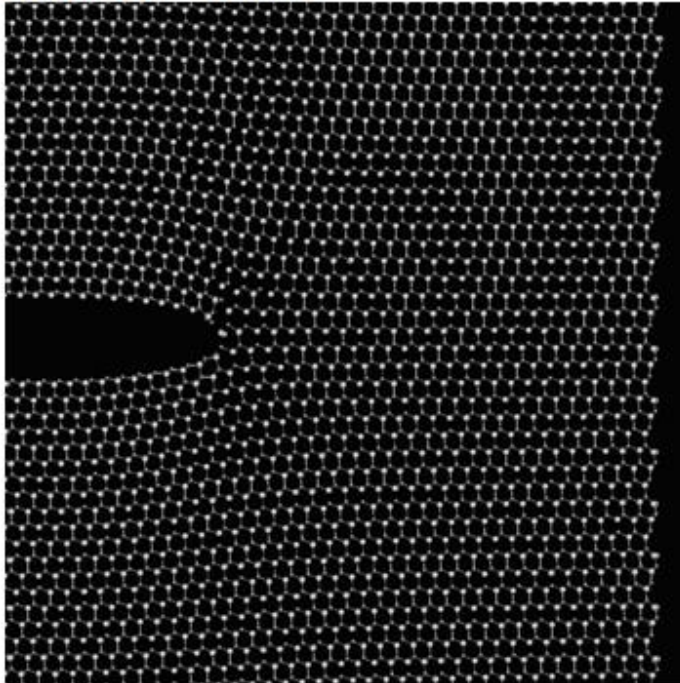


# MD Results

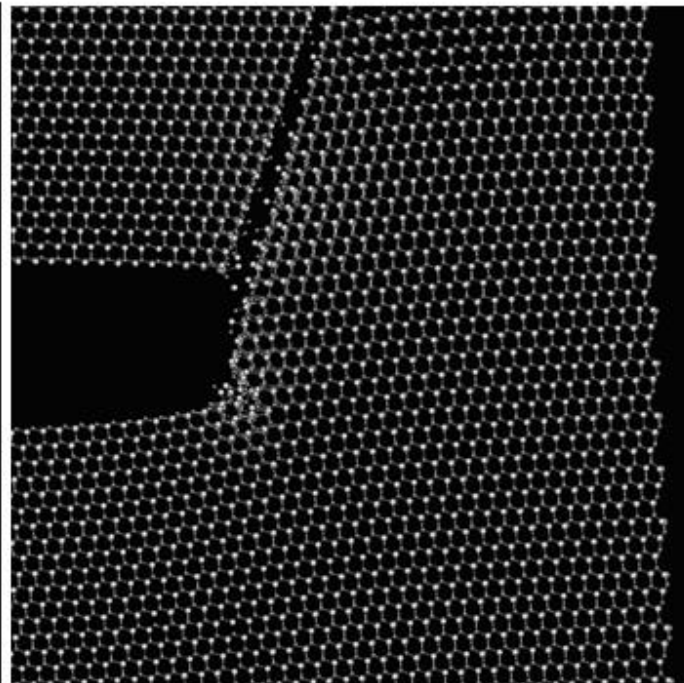
Erhart potential

Temperature = 0 K

Strain rate =  $1e7$  /s



$\varepsilon = 0.047$



$\varepsilon = 0.063$

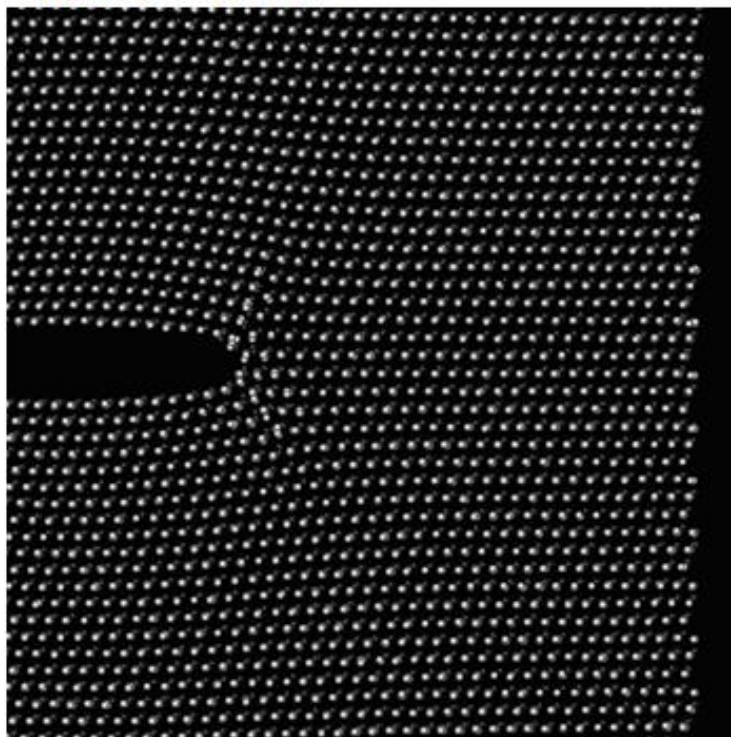
Crack does not have ductile response. Crack initiates on  $\{111\}$  plane perpendicular to loading direction and continues to propagate on the inclined  $\{111\}$  planes.

# MD Results

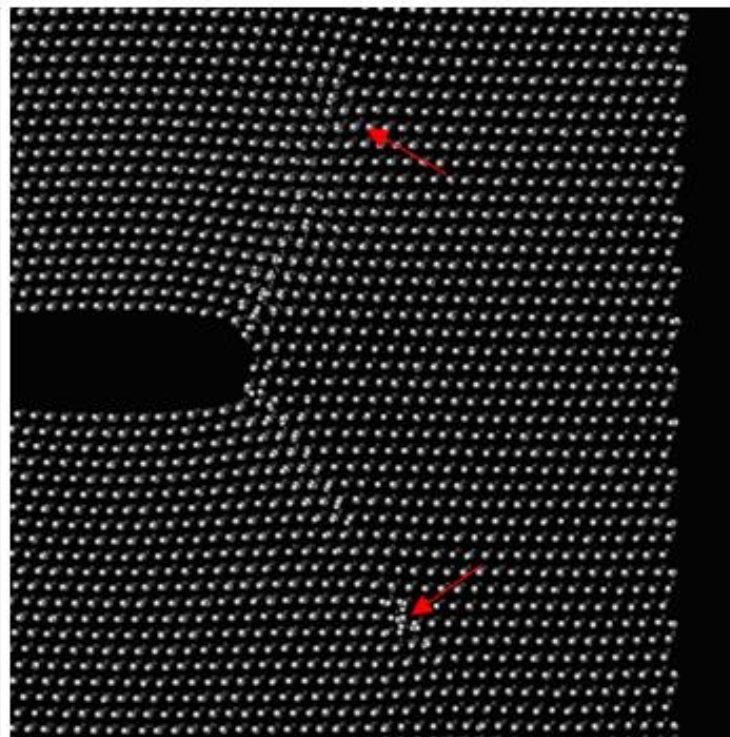
Erhart potential

Temperature = 400 K

Strain rate =  $1e7$  /s



$\varepsilon = 0.039$



$\varepsilon = 0.055$

Ductile crack response by nucleation of dislocations on  $\{111\}$  and  $\{100\}$  planes. Leading partial and trailing partial are formed on  $\{111\}$  plane. Full  $\{100\}$  dislocation is mobile at 400 K. No twinning is observed.

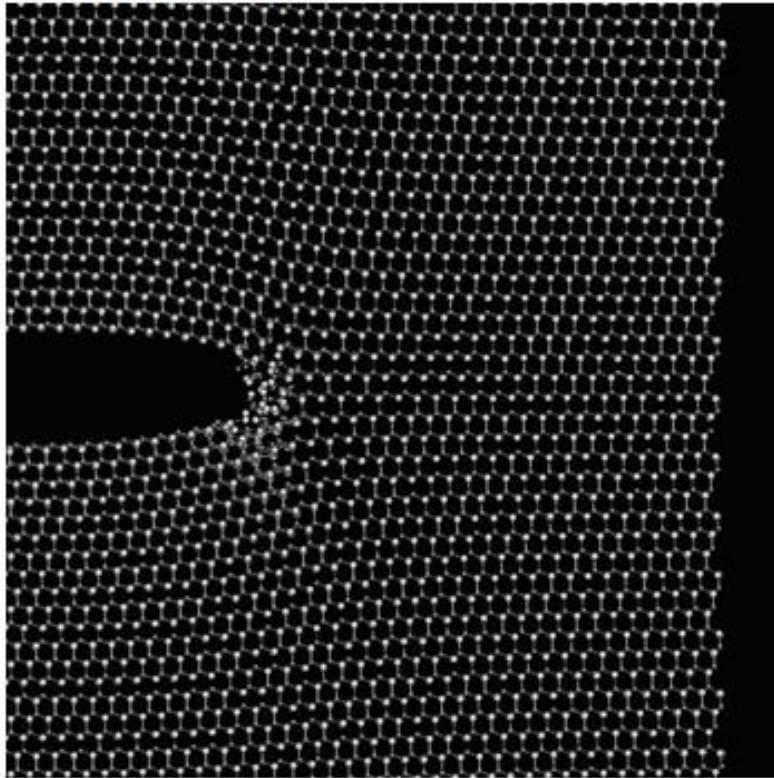


# MD Results

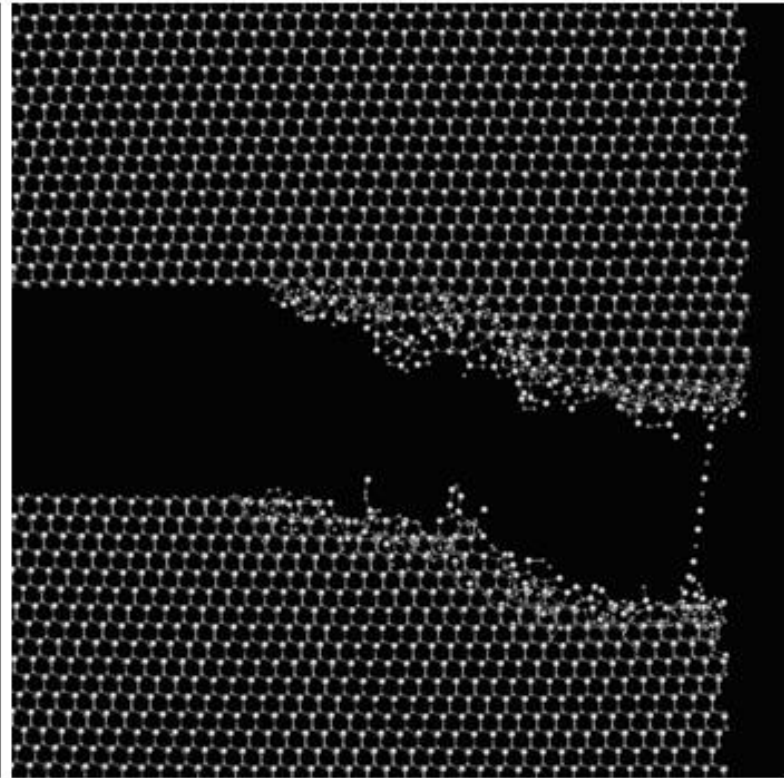
Devanathan potential

Temperature = 0 K

Strain rate =  $1e7$  /s



$\epsilon = 0.056$

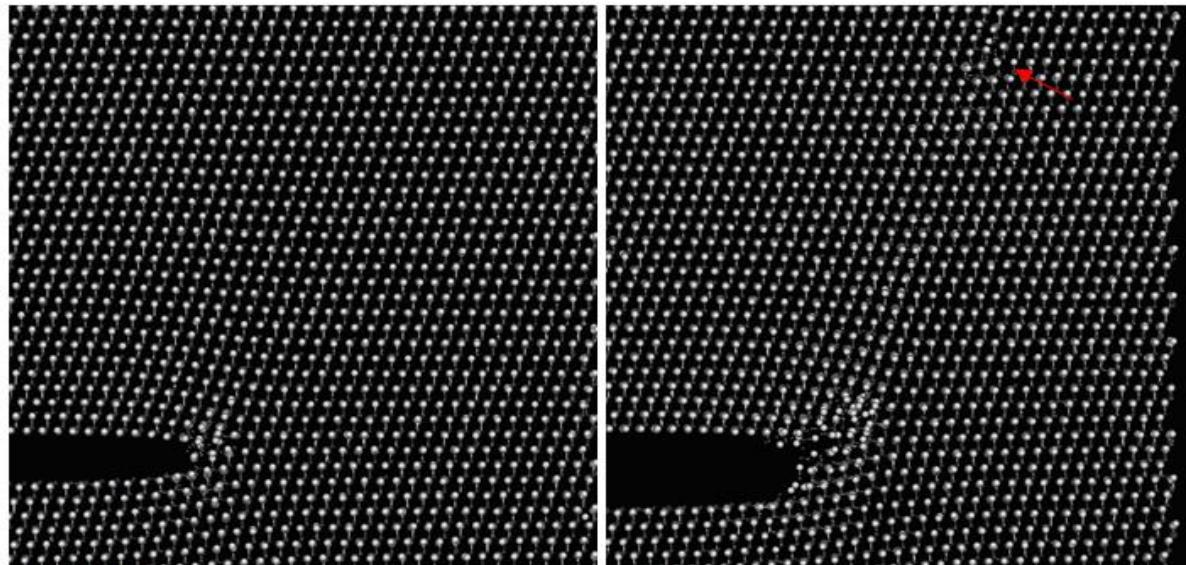
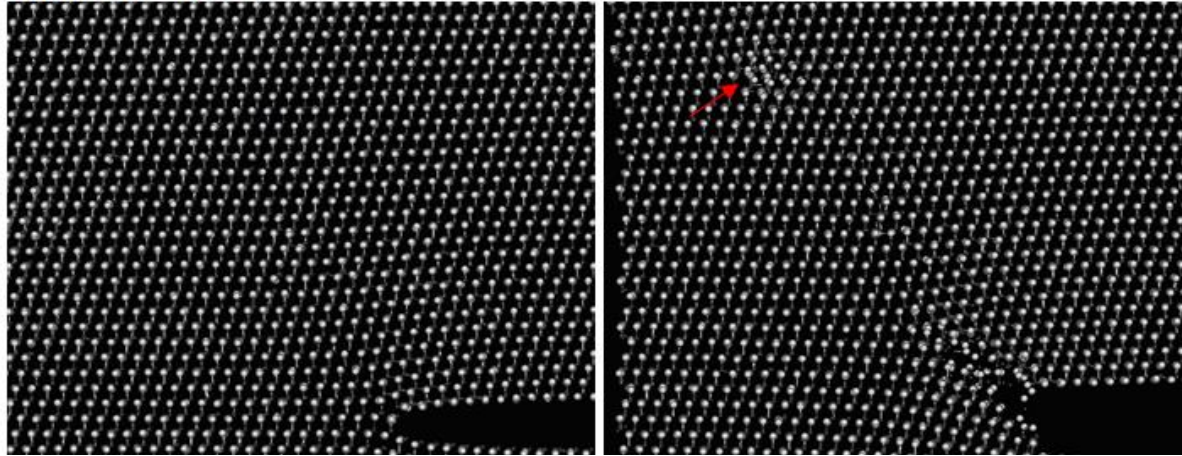


$\epsilon = 0.068$

Brittle crack initiates on  $\{111\}$  plane and continues to grow catastrophically

# MD Results

Devanathan potential  
Temperature = 1000 K  
Strain rate =  $1e7$  /s



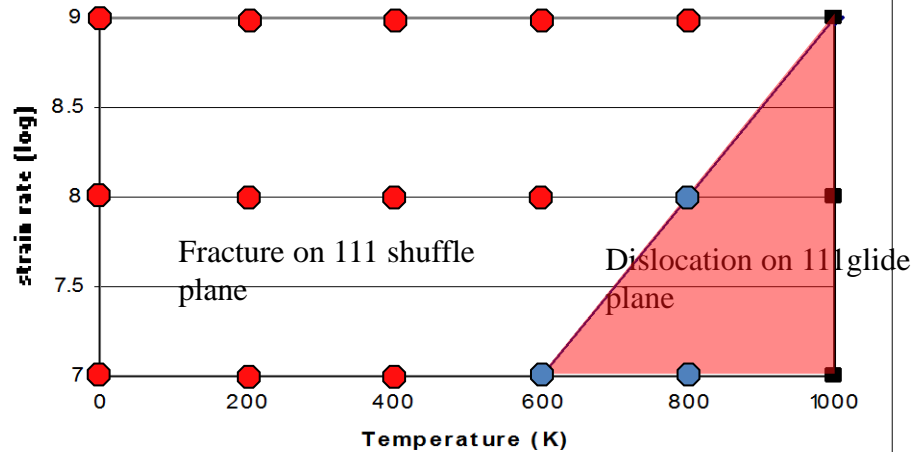
$\varepsilon = 0.028$

$\varepsilon = 0.036$

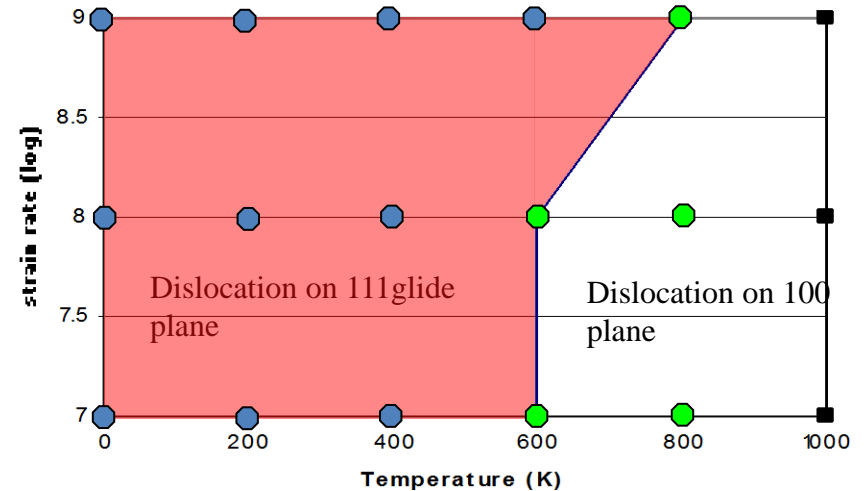
Dislocation nucleates on both  $\{111\}$  and  $\{100\}$  planes.

# MD Results

Failure Mechanism (Devanathan Tersoff Potential)



Failure Mechanism (Erhart Tersoff Potential)



# **Part II:**

# **Analytic Continuum Model**

# Continuum Modeling

## Mode I

fracture

- Consider a mode I crack, if the strain energy release rate is greater than the surface energy, the crack will propagate

$$G_I = (1-\nu)K_I^2 / 2\mu > 2\gamma_s$$

dislocation

- For mode I crack loading, the dislocation nucleation criterion  $G_I > g(\gamma_{us})$

$$G_I = \frac{(1-\nu)K_I^2}{2\mu} > 8 \frac{1 + (1-\nu) \tan^2 \phi}{(1 + \cos \theta) \sin^2 \theta} \gamma_{us}$$

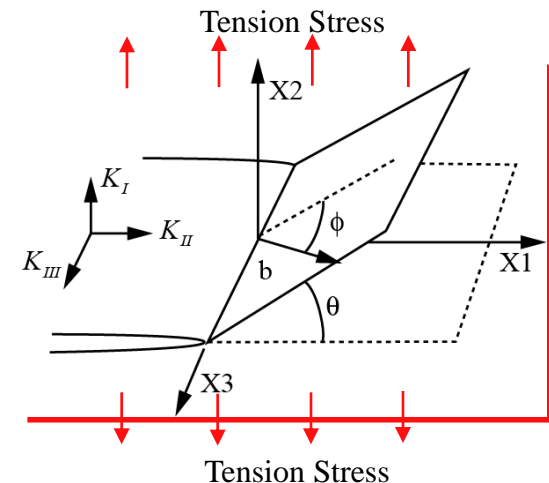
## Mode II

- Consider a mode II crack, new surface is formed when Griffith criterion for fracture is fulfilled:  $G_{II} > g(\gamma_s)$

$$G_{II} = (1-\nu)K_{II}^2 / 2\mu > 2\gamma_s$$

- If the strain energy release rate is greater than the unstable stacking fault energy, dislocation will nucleate:  $G_{II} > g(\gamma_{us})$

$$G_{II} = (1-\nu)K_{II}^2 / 2\mu > 2\gamma_{us}$$





# Strain Rate and Temperature Dependence

- Activation energy for nucleating a dislocation in 3 dimension [1]

$$Q_{3D} = 5b_p^3 0.287 \mu F \frac{(\cos^2 \varphi + (1-\nu) \sin^2 \varphi)}{(1-\nu)} \left( 1 - \frac{K_{II}^{eff}}{K_{IIcrit}^{eff}} \right)^{\frac{3}{2}}$$

- The effective KII stress intensity factor is given by the applied KI and the geometry

$$K_{II}^{eff} = K_I \cos \phi \cos^2 \frac{\theta}{2} \sin \frac{\theta}{2}$$

- The critical KII stress intensity factor is a function of the elastic constants and the unstable stacking fault energy

$$K_{IIcrit}^{eff} = \sqrt{\frac{2\mu}{1-\nu}} (\cos^2 \varphi + (1-\nu) \sin^2 \varphi) \gamma_{us}$$

- Finally, the critical KI stress intensity factor for dislocation nucleation can be solved numerically at given temperature and strain rate [2]

$$\frac{Q_{3D}}{k_B T} = \ln \left( \frac{k_B T N \omega_0}{-\dot{K}_I \frac{dQ_{3D}}{dK_I}} \right)$$

- Analytic continuum fracture and dislocation model:

- Elastic constants

$$C_{11}(T), C_{12}(T), C_{44}(T)$$

- Surface energies

$$\gamma_s(T)$$

- Unstable Stacking fault energies

$$\gamma_{us}(T)$$

# Elastic Constants

- Elastic constants input for continuum model
- Direct calculation of elastic constants with Lammmps
- 0K elastic constants compared to experiments

	Experiment [1]	Experiment [2]	This work Erhart	This work Devanathan
a0	4.3596		4.3596	4.2799
C11	390	352	380	437
C12	142	140	138	126
C44	256	233	239	265

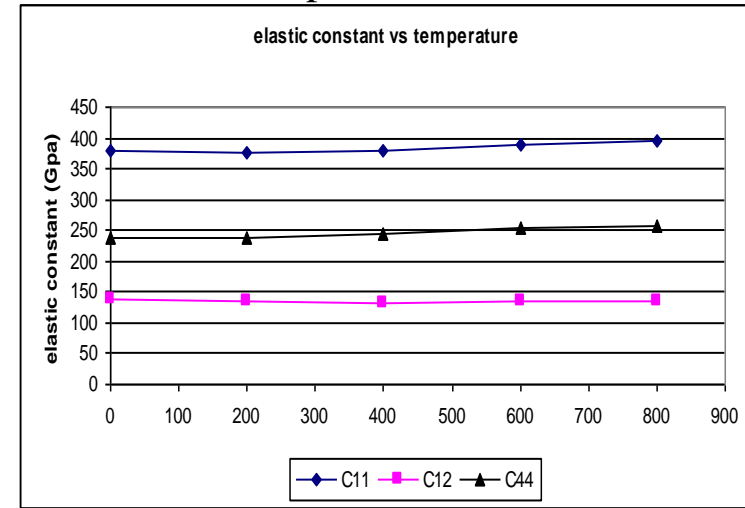
- Elastic constants as a function of temperature with NPT
- Elastic constants increase with temperature for Devanathan Tersoff potential, also observed in [3]

[1] - W. R. L. Lambrecht, 1991d.

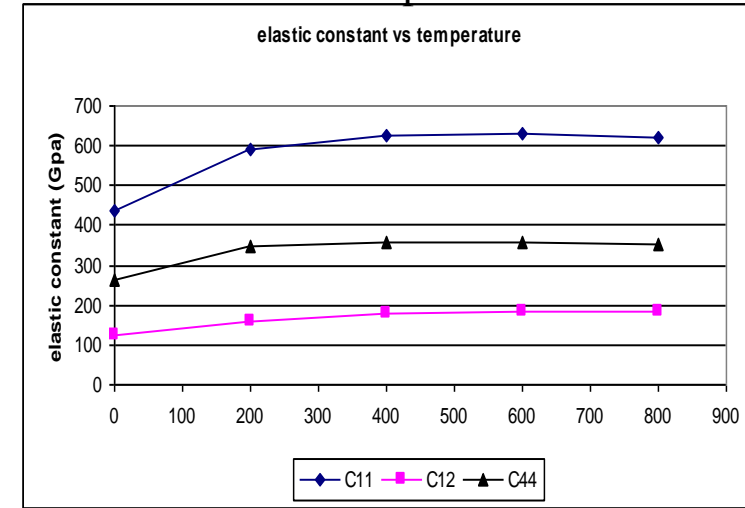
[2] - H. Ullmeier, 2001d.

[3] - J. David Schall, 2008

## Erhart Tersoff potential



## Devanathan Tersoff potential



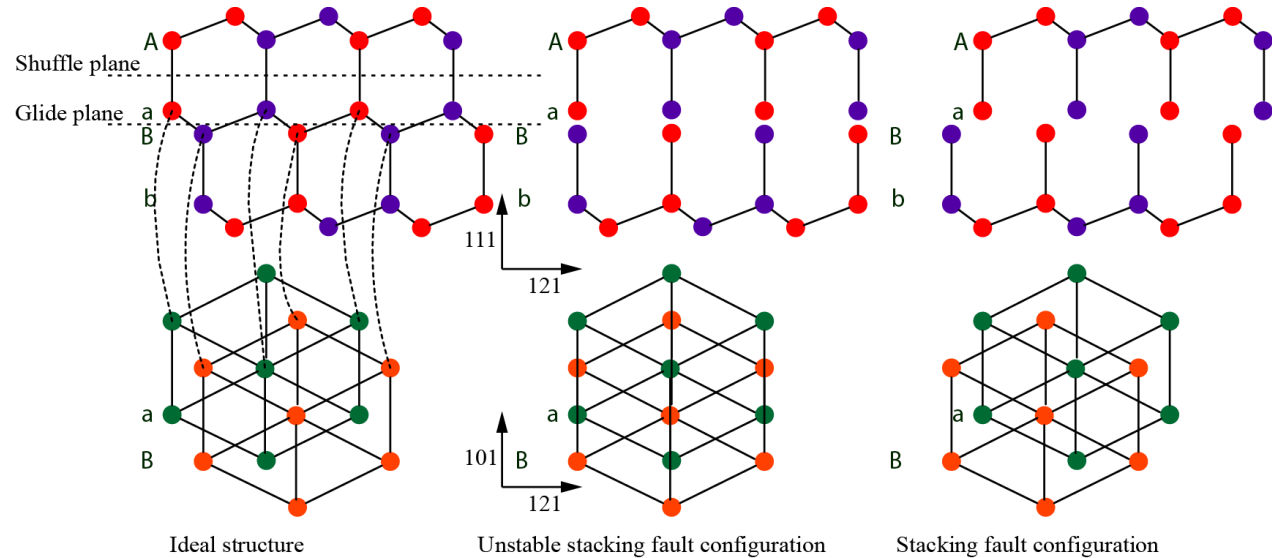
# Surface Energies

	<u>T(K)</u>	<u>Devanathan Tersoff Potential energy (J/m<sup>2</sup>)</u>	<u>Erhart Tersoff Potential energy (J/m<sup>2</sup>)</u>	<u>DFT Perdew-Zunger (LDA) exch-corr energy (J/m<sup>2</sup>)</u>
111 glide plane	0.00	15.61	13.86	13.82
	800.00 (enthalpy)	10.17	9.31	-
111 shuffle plane	0.00	6.80	5.08	8.28
	800.00 (enthalpy)	6.40	4.84	-
100 plane	0.00	11.37	9.75	10.10
	800.00 (enthalpy)	9.60	8.73	-

- Surface energies input for fracture criterion
- Direct calculation of surface energies with Lammmps
- $\gamma(111 \text{ shuffle plane}) < \gamma(100 \text{ plane}) < \gamma(111 \text{ glide plane})$
- 111 shuffle plane is the most preferable fracture plane
- The 111 shuffle plane surface energy computed with DFT is higher

# Unstable Stacking Fault Energies

- Input for dislocation criterion
- moving one half of the crystal rigidly in the direction of the Burgers vector
- Most preferable dislocation planes are 111 glide plane and 100 plane for Erhart potential

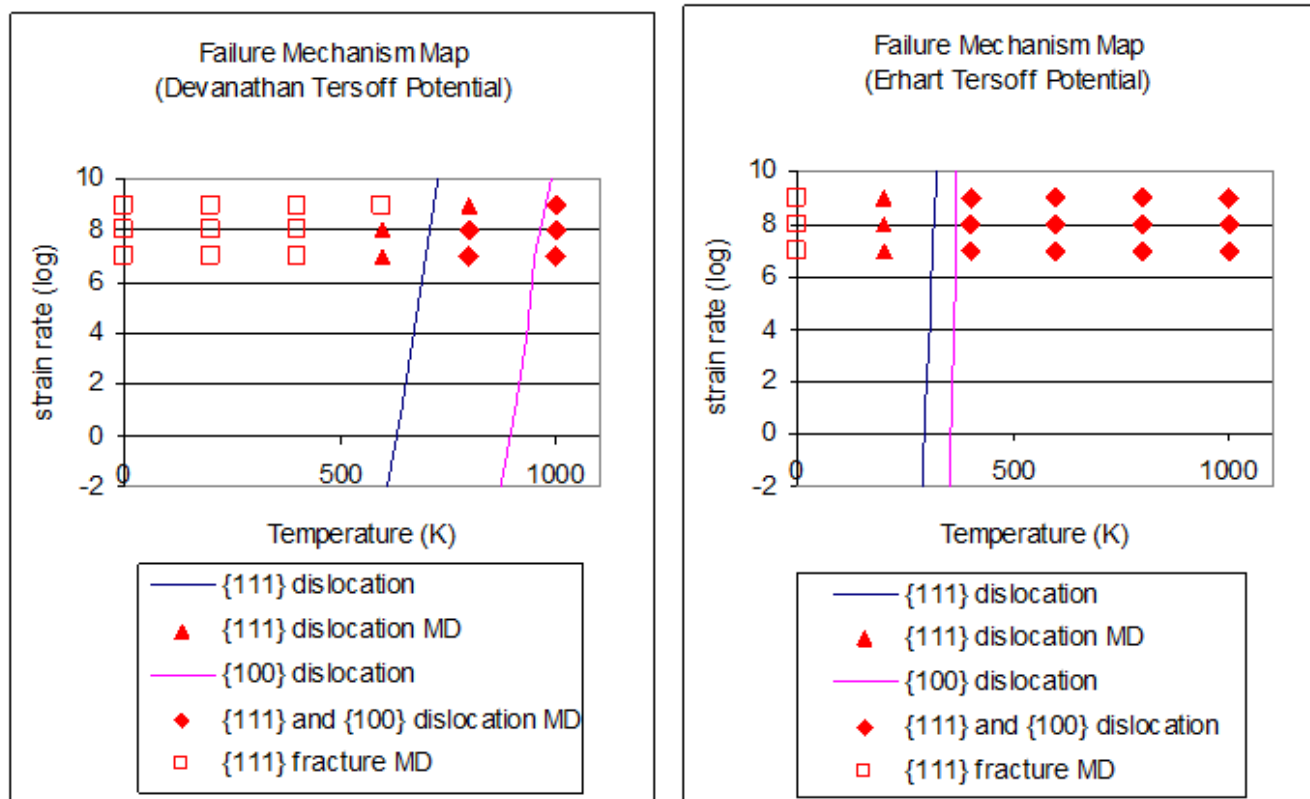


	T(K)	Devanathan Tersoff Potential energy (J/m <sup>2</sup> )	Erhart Tersoff Potential energy (J/m <sup>2</sup> )	DFT TPSS (Tao-Perdew-Staroverov-Scuseria) GGA
111 glide plane (partial)	0.00	6.15	2.82	3.00
	800.00	5.82	2.76	-
111 shuffle plane	0.00	6.72	6.51	4.00
	800.00	6.20	3.93	-
100 u direction	0.00	9.12	7.86	7.57
	800.00	9.03	7.76	-
100 v direction	0.00	12.22	7.86	-
	800.00	8.19	2.18	-

# **Part III:**

## **MD Model vs Analytic Model**

# Failure Mechanism Map



Failure mechanism map for Devanathan and Erhart Tersoff potential

The continuum model predicts fracture on the {111} plane to the left of the blue curve. Between the blue and magenta curve, the model predicts dislocation initiates only on {111} glide plane. To the right of the magenta curve, both {111} and {100} dislocations are predicted. Open squares denote fracture in MD simulation. Triangle and diamond denote dislocation on {111} plane and both {111} and {100} planes respectively.

# Summary

- Three competing crack tip mechanisms:
  - Cleavage on 111 plane
  - Dislocation nucleation on  $\{111\}$  planes (glide set)
  - Dislocation nucleation on  $\{100\}$  planes
- The competition between these mechanisms was critically examined using atomistic simulation analytic continuum modeling as a function of temperature and strain rate
- Crack tip mechanism map for SiC – cleavage at low temperature and high strain rate and dislocation nucleation at high temperature and low strain rate
- Future directions:
  - Mobility of different types of dislocation vs brittle ductile transition
  - The impurity effect on cleavage and dislocation nucleation

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## Overview

**Primary Objective:** Utilize advanced atomistic modeling techniques to investigate the role of impurity elements and nonstoichiometry on high temperature SiC crack tip behavior

**Timeline:** 3 year project  
Initiated September 15, 2011

### Potential Outcomes:

1. Improve understanding of fracture mechanisms in SiC
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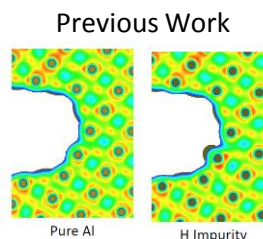
**Technical Challenges:** Four longstanding challenges exist for performing meaningful atomistic simulations of deformation and fracture processes

1. Spatial scaling
2. Temporal scaling
3. Interatomic interactions
4. Vast configuration space

## Approach

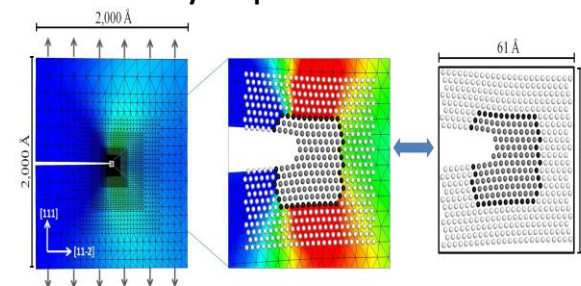
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3. Examine the effect of impurities and nonstoichiometry on the key mechanisms and configurations
  - QM-based continuum models

The images to the right show the difference in electron density at an aluminum crack tip when a single hydrogen element is present



## Highlighted Tools

### Concurrently Coupled Multiscale Simulation



### Quantum Mechanics Based Coupled Atomistic Discrete Dislocation Method (QM-CADD)

- Force balance coupling → simple quantum-continuum mechanical coupling
- No ghost forces + quantifiable & controllable coupling errors

### Accelerated Timescale Atomistic Simulations

We use several techniques to extend the timescale which our simulation can probe. The below image depicts the hyperdynamics approach

